



CY74FCT163244

CY74FCT163H244

16 Bit Buffers/Line Drivers

Features

- 5V tolerant inputs and outputs
- 24 mA balanced drive outputs
- Low power, pin-compatible replacement for LCX, LPT, LVC, LVCH & LVT families
- FCT-C speed at 4.1 ns
- Power-off disable outputs permits live insertion
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Extended commercial temperature range of -40°C to +85°C
- V_{CC} = 2.7V to 3.6V
- Typical V_{OLP} (ground bounce) <0.6V at V_{CC} = 3.3V, T_A = 25°C

CY74FCT163H244 Features:

- Bus hold on data inputs
- Eliminates the need for external pull-up or pull-down resistors

Functional Description

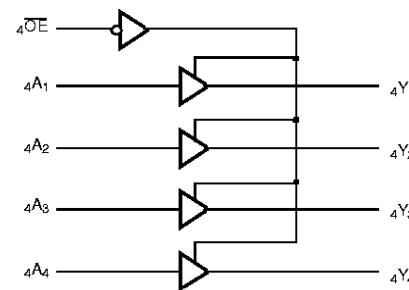
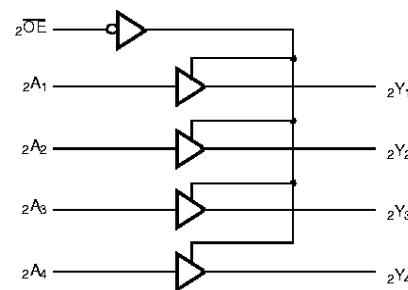
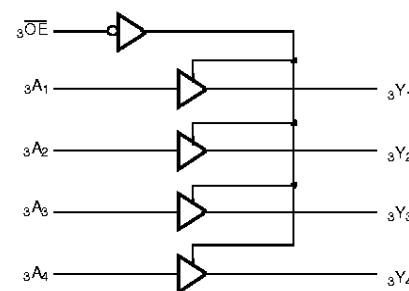
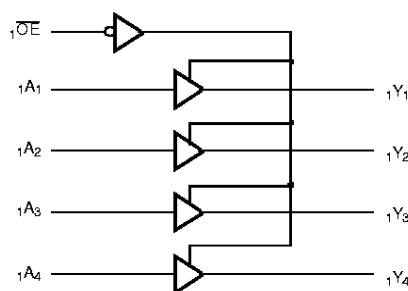
These 16-bit buffers/line drivers are designed for use in memory driver, clock driver, or other bus interface applications, where high-speed and low power are required. The three-state controls are designed to allow 4-bit, 8-bit or combined 16-bit operation. Flow-through pinout and small shrink packaging simplifies board layout.

The CY74FCT163244 has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce.

The CY74FCT163H244 has "bus hold" on the data inputs, which retain the input's last state whenever the source driving the input goes to high impedance. This eliminates the need for pull-up/down resistors and prevents floating inputs.

The CY74FCT163244 and the CY74FCT163H244 are designed with inputs and outputs capable of being driven by 5.0 V busses, allowing them to be used in mixed voltage systems as translators. The outputs are also designed with a power off disable feature enabling them to be used in applications requiring live insertion.

Logic Block Diagrams CY74FCT163244, CY74FCT163H244



Pin Configuration

SSOP/TSSOP Top View	
1 _{OE}	1
1 _{Y1}	2
1 _{Y2}	3
GND	4
1 _{Y3}	5
1 _{Y4}	6
V _{CC}	7
2 _{Y1}	8
2 _{Y2}	9
GND	10
2 _{Y3}	11
2 _{Y4}	12
3 _{Y1}	13
3 _{Y2}	14
GND	15
3 _{Y3}	16
3 _{Y4}	17
V _{CC}	18
4 _{Y1}	19
4 _{Y2}	20
GND	21
4 _{Y3}	22
4 _{Y4}	23
4 _{OE}	24
2 _{OE}	25

Pin Description

Name	Description
OE	Three-State Output Enable Inputs (Active LOW)
A	Data Inputs ^[1]
Y	Three-State Outputs

Function Table^[2]

Inputs		Outputs
OE	A	Y
L	L	L
L	H	H
H	X	Z

Notes:

1. On the CY74FCT163H244, these pins have "bus hold."
2. H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care. Z = High Impedance.
3. Operation beyond the limits set forth may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.
4. With the exception of inputs with bus hold, unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.

Maximum Ratings^[3,4]

(Above which the useful life may be impaired. For user guidelines, not tested.)	
Storage Temperature.....	-55°C to +125°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage Range.....	0.5V to +4.6V
DC Input Voltage	-0.5V to +7.0V
DC Output Voltage	-0.5V to +7.0V
DC Output Current (Maximum Sink Current/Pin)	-60 to +120 mA
Power Dissipation.....	1.0W
Static Discharge Voltage	>2001V (per MIL-STD-883, Method 3015)

Operating Range

Range	Ambient Temperature	V_{CC}
Commercial	-40°C to +85°C	2.7V to 3.6V

Electrical Characteristics

Over the Operating Range $V_{CC}=2.7V$ to 3.6V

Parameter	Description		Test Conditions		Min.	Typ. ^[5]	Max.	Unit
V_{IH}	Input HIGH Voltage		All Inputs		2.0		5.5	V
V_{IL}	Input LOW Voltage						0.8	V
V_H	Input Hysteresis ^[6]				100			mV
V_{IK}	Input Clamp Diode Voltage		$V_{CC}=\text{Min.}, I_{IN}=-18\text{ mA}$			-0.7	-1.2	V
I_{IH}	Input HIGH Current	Standard	$V_{CC}=\text{Max.}, V_I=5.5$				± 1	μA
		Bus Hold	$V_{CC}=\text{Max.}, V_I=V_{CC}$				± 100	
I_{IL}	Input LOW Current	Standard	$V_{CC}=\text{Max.}, V_I=GND$				± 1	μA
		Bus Hold					± 100	
I_{BBH} I_{BBL}	Bus Hold Sustain Current on Bus Hold Input ^[7]		$V_{CC}=\text{Min.}$	$V_I=2.0V$	-50			μA
				$V_I=0.8V$	+50			μA
I_{BHHO} I_{BHLO}	Bus Hold Overdrive Current on Bus Hold Input ^[7]		$V_{CC}=\text{Max.}, V_I=1.5V$				± 500	μA
I_{OZH}	High Impedance Output Current (Three-State Output pins)	Standard	$V_{CC}=\text{Max.}, V_{OUT}=5.5V$				± 1	μA
		Bus Hold	$V_{CC}=\text{Max.}, V_{OUT}=V_{CC}$				± 1	μA
I_{OZL}	High Impedance Output Current (Three-State Output pins)		$V_{CC}=\text{Max.}, V_{OUT}=GND$				± 1	μA
I_{ODL}	Output LOW Current ^[8]		$V_{CC}=3.3V, V_{IN}=V_{IH}$ or $V_{IL}, V_{OUT}=1.5V$		50	90	200	mA
I_{ODH}	Output HIGH Current ^[8]		$V_{CC}=3.3V, V_{IN}=V_{IH}$ or $V_{IL}, V_{OUT}=1.5V$		-36	-60	-110	mA
V_{OH}	Output HIGH Voltage		$V_{CC}=\text{Min.}, I_{OH}=-0.1\text{ mA}$	$V_{CC}-0.2$				V
			$V_{CC}=\text{Min.}, I_{OH}=-8\text{ mA}$	2.4 ^[9]	3.0			V
			$V_{CC}=3.0V, I_{OH}=-24\text{ mA}$	2.0	3.0			V

Electrical Characteristics Over the Operating Range $V_{CC}=2.7V$ to $3.6V$ (Continued)

Parameter	Description	Test Conditions	Min.	Typ. ^[5]	Max.	Unit
I_{OL}	Output LOW Voltage	$V_{CC}=\text{Min.}$, $I_{OL}=0.1\text{mA}$			0.2	V
		$V_{CC}=\text{Min.}$, $I_{OL}=24\text{ mA}$		0.3	0.5	
I_{OS}	Short Circuit Current ^[8]	$V_{CC}=\text{Max.}$, $V_{OUT}=\text{GND}$	-60	-135	-240	mA
I_{OFF}	Power-Off Disable	$V_{CC}=0V$, $V_{OUT}\leq4.5V$			± 100	μA

Capacitance ^[6] ($T_A = +25^\circ\text{C}$, $f = 1.0\text{ MHz}$)

Parameter	Description	Test Conditions	Typ. ^[5]	Max.	Unit
C_{IN}	Input Capacitance	$V_{IN}=0V$	4.5	6.0	pF
C_{OUT}	Output Capacitance	$V_{OUT}=0V$	5.5	8.0	pF

Power Supply Characteristics

Parameter	Description	Test Conditions	Typ. ^[5]	Max.	Unit	
I_{CC}	Quiescent Power Supply Current	$V_{CC}=\text{Max.}$	$V_{IN}\leq 0.2V$, $V_{IN}\leq V_{CC}-0.2V$	0.1	10	μA
ΔI_{CC}	Quiescent Power Supply Current (TTL inputs HIGH)	$V_{CC}=\text{Max.}$	$V_{IN}=V_{CC}-0.6V$ ^[10]	2.0	30	μA
I_{CCD}	Dynamic Power Supply Current ^[11]	$V_{CC}=\text{Max.}$, One Input Toggling, 50% Duty Cycle, Outputs Open, $\overline{OE}=\text{GND}$	$V_{IN}=V_{CC}$ or $V_{IN}=\text{GND}$	50	75	$\mu\text{A/MHz}$
I_C	Total Power Supply Current ^[12]	$V_{CC}=\text{Max.}$, $f_1=10\text{ MHz}$, 50% Duty Cycle, Outputs Open, One Bit Toggling, $\overline{OE}=\text{GND}$	$V_{IN}=V_{CC}$ or $V_{IN}=\text{GND}$	0.5	0.8	mA
			$V_{IN}=V_{CC}-0.6V$ or $V_{IN}=\text{GND}$	0.5	0.8	mA
		$V_{CC}=\text{Max.}$, $f_1=2.5\text{ MHz}$, 50% Duty Cycle, Outputs Open, Six- teen Bits Toggling, $\overline{OE}=\text{GND}$	$V_{IN}=V_{CC}$ or $V_{IN}=\text{GND}$	2.0	$3.0^{[13]}$	mA
			$V_{IN}=V_{CC}-0.6V$ or $V_{IN}=\text{GND}$	2.0	$3.3^{[13]}$	mA

Notes:

5. Typical values are at $V_{CC}=3.3V$, $T_A = +25^\circ\text{C}$ ambient.
 6. This parameter is guaranteed but not tested.
 7. Pins with bus hold are described in Pin Description.
 8. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I_{OS} tests should be performed last.
 9. $V_{OH}=V_{CC}-0.6\text{ V}$ at rated current.
 10. Per TTL driven input; all other inputs at V_{CC} or GND.
 11. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
 12. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$
 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_0/2 + f_1 N_1)$
 I_{CC} = Quiescent Current with CMOS input levels
 ΔI_{CC} = Power Supply Current for a TTL HIGH input ($V_{IN}=3.4V$)
 D_H = Duty Cycle for TTL inputs HIGH
 N_T = Number of TTL inputs at D_H
 I_{CCD} = Dynamic Current caused by an input transition pair (HLH or LHL)
 f_0 = Clock frequency for registered devices, otherwise zero
 f_1 = Input signal frequency
 N_1 = Number of inputs changing at f_1
- All currents are in millamps and all frequencies are in megahertz.
13. Values for these conditions are examples of the I_C formula. These limits are guaranteed but not tested.

**CY74FCT163244****CY74FCT163H244****Switching Characteristics Over the Operating Range $V_{CC}=3.0V$ to $3.6V^{[14,15]}$**

Parameter	Description	CY74FCT163244A CY74FCT163H244A		CY74FCT163244C CY74FCT163H244C		Unit	Fig. No.^[16]
		Min.	Max.	Min.	Max.		
t_{PLH}	Propagation Delay Data to Output	1.5	4.8	1.5	4.1	ns	1, 3
t_{PHL}	Output Enable Time	1.5	6.2	1.5	5.8	ns	1, 7, 8
t_{PHZ}	Output Disable Time	1.5	5.6	1.5	5.2	ns	1, 7, 8
t_{PLZ}							
$t_{SK(O)}$	Output Skew ^[17]		0.5		0.5	ns	—

Notes:

14. Minimum limits are guaranteed but not tested on Propagation Delays.
15. For $V_{CC}=2.7$, propagation delay, output enable and output disable times should be degraded by 20%.
16. See "Parameter Measurement Information" in the General Information section.
17. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

Ordering Information CY74FCT163244

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
4.1	CY74FCT163244CPAC	Z48	48-Lead (240-Mil) TSSOP	Commercial
	CY74FCT163244CPVC	O48	48-Lead (300-Mil) SSOP	
4.8	CY74FCT163244APAC	Z48	48-Lead (240-Mil) TSSOP	Commercial
	CY74FCT163244APVC	O48	48-Lead (300-Mil) SSOP	

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	CY74FCT163H244CPVC	O48	48-Lead (300-Mil) SSOP	
4.8	CY74FCT163H244APAC	Z48	48-Lead (240-Mil) TSSOP	Commercial
	CY74FCT163H244APVC	O48	48-Lead (300-Mil) SSOP	

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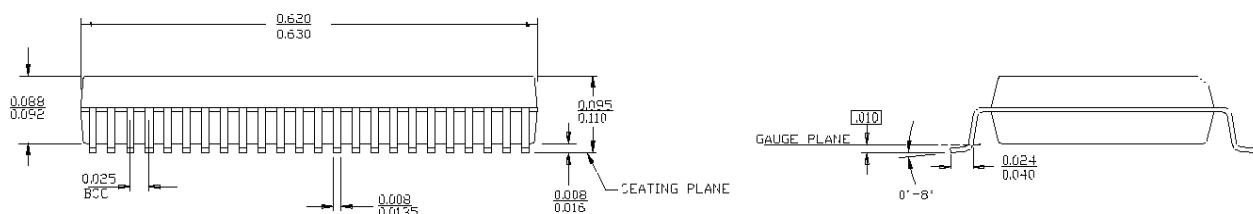
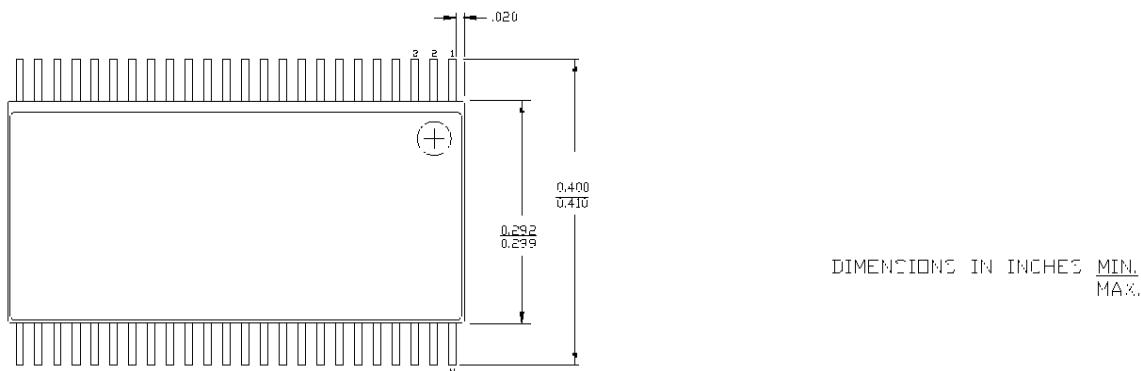


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Package Diagrams

48-Lead Shrunk Small Outline Package O48



48-Lead Thin Shrunk Small Outline Package Z48

